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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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INSULATED GATE BIPOLAR TRANSISTOR WITH
ULTRAFAST SOFT RECOVERY DIODE

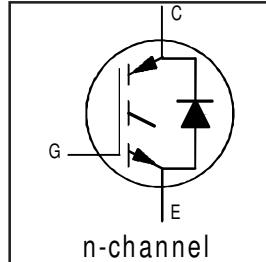
Short Circuit Rated
UltraFast IGBT

Features

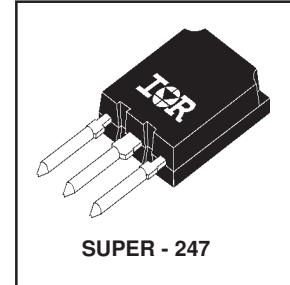
- Hole-less clip/pressure mount package compatible with TO-247 and TO-264, with reinforced pins
- High abort circuit rating IGBTs, optimized for motorcontrol
- Minimum switching losses combined with low conduction losses
- Tightest parameter distribution
- IGBT co-packaged with ultrafast soft recovery antiparallel diode
- Creepage distance increased to 5.35mm

Benefits

- Highest current rating copack IGBT
- Maximum power density, twice the power handling of the TO-247, less space than TO-264
- HEXFRED™ diode optimized for operation with IGBT, to minimize EMI, noise and switching losses



$V_{CES} = 600V$
 $V_{CE(on)} \text{ typ.} = 1.83V$
 $\text{@ } V_{GE} = 15V, I_C = 60A$



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	600	V
$I_C @ T_C = 25^\circ\text{C}$	Continuous Collector Current	85⑤	A
$I_C @ T_C = 100^\circ\text{C}$	Continuous Collector Current	60	
I_{CM}	Pulsed Collector Current ①	200	
I_{LM}	Clamped Inductive Load Current ②	200	
$I_F @ T_C = 100^\circ\text{C}$	Diode Continuous Forward Current	50	
I_{FM}	Diode Maximum Forward Current	200	
t_{sc}	Short Circuit Withstand Time	10	μs
V_{GE}	Gate-to-Emitter Voltage	± 20	V
$P_D @ T_C = 25^\circ\text{C}$	Maximum Power Dissipation	350	W
$P_D @ T_C = 100^\circ\text{C}$	Maximum Power Dissipation	140	
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	$^\circ\text{C}$

Thermal Resistance\ Mechanical

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	—	—	0.36	$^\circ\text{C/W}$
$R_{\theta JC}$	Junction-to-Case - Diode	—	—	0.69	
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	38	
	Recommended Clip Force	20.0(2.0)	—	—	N (kgf)
	Weight	—	6 (0.21)	—	g (oz)

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage③	600	—	—	V	$V_{\text{GE}} = 0\text{V}$, $I_C = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.5	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$, $I_C = 10\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	1.83	2.3	V	$I_C = 60\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	2.20	—		$I_C = 100\text{A}$ See Fig. 2, 5
		—	1.81	—		$I_C = 60\text{A}$, $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-8.0	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 1.5\text{mA}$
g_{fe}	Forward Transconductance ④	31	46	—	S	$V_{\text{CE}} = 50\text{V}$, $I_C = 60\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	500	μA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$
		—	—	13	mA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$, $T_J = 150^\circ\text{C}$
V_{FM}	Diode Forward Voltage Drop	—	1.4	1.7	V	$I_C = 60\text{A}$ See Fig. 13
		—	1.3	—		$I_C = 60\text{A}$, $T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	340	510	nC	$I_C = 60\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	44	66		$V_{\text{CC}} = 400\text{V}$ See Fig.8
Q_{gc}	Gate - Collector Charge (turn-on)	—	160	240		$V_{\text{GE}} = 15\text{V}$
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	82	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 60\text{A}$, $V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$ Energy losses include "tail" and diode reverse recovery See Fig. 9,10,18
t_r	Rise Time	—	107	—		
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	282	423		
t_f	Fall Time	—	97	146		
E_{on}	Turn-On Switching Loss	—	3.95	—	mJ	See Fig. 9,10,18
E_{off}	Turn-Off Switching Loss	—	2.33	—		
E_{ts}	Total Switching Loss	—	6.28	7.7		
t_{sc}	Short Circuit Withstand Time	10	—	—	μs	$V_{\text{CC}} = 360\text{V}$, $T_J = 125^\circ\text{C}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$, $V_{\text{CPK}} < 500\text{V}$
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	87	—	ns	$T_J = 150^\circ\text{C}$, See Fig. 11,18 $I_C = 60\text{A}$, $V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$ Energy losses include "tail" and diode reverse recovery
t_r	Rise Time	—	104	—		
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	374	—		
t_f	Fall Time	—	143	—		
E_{ts}	Total Switching Loss	—	8.5	—	mJ	Measured 5mm from package
L_E	Internal Emitter Inductance	—	13	—	nH	
C_{ies}	Input Capacitance	—	6900	—	pF	
C_{oes}	Output Capacitance	—	730	—	$V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$	
C_{res}	Reverse Transfer Capacitance	—	190	—		
t_{rr}	Diode Reverse Recovery Time	—	82	120	ns	$T_J = 25^\circ\text{C}$ See Fig.
		—	140	210		$T_J = 125^\circ\text{C}$ 14
I_{rr}	Diode Peak Reverse Recovery Current	—	8.2	12	A	$T_J = 25^\circ\text{C}$ See Fig.
		—	13	20		$T_J = 125^\circ\text{C}$ 15
Q_{rr}	Diode Reverse Recovery Charge	—	364	546	nC	$T_J = 25^\circ\text{C}$ See Fig.
		—	1084	1625		$T_J = 125^\circ\text{C}$ 16
$di_{(\text{rec})M/dt}$	Diode Peak Rate of Fall of Recovery During t_b	—	328	—	A/ μs	$T_J = 25^\circ\text{C}$ See Fig.
		—	266	—		$T_J = 125^\circ\text{C}$ 17

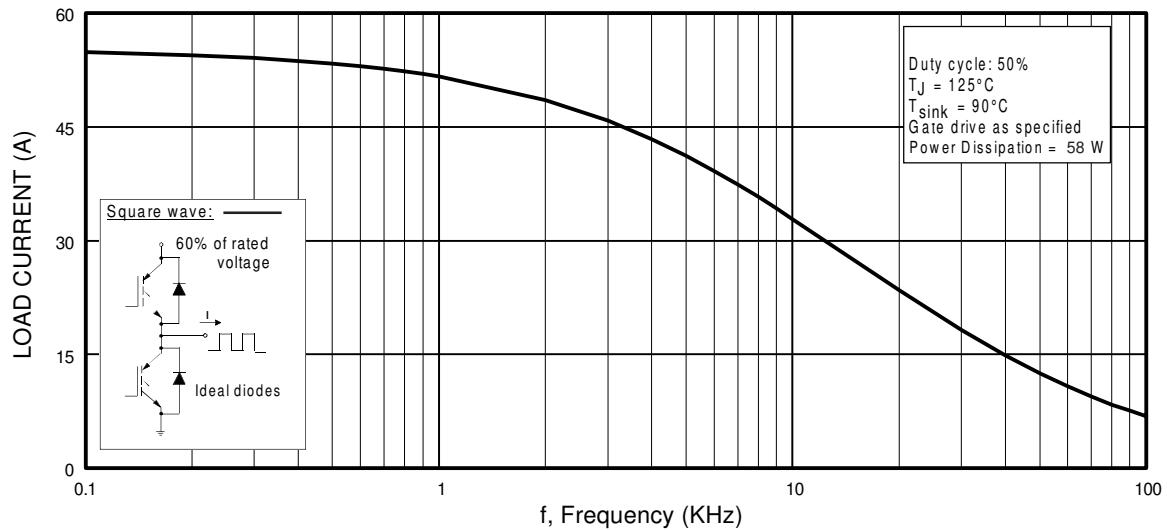


Fig. 1 - Typical Load Current vs. Frequency
 (Load Current = I_{RMS} of fundamental)

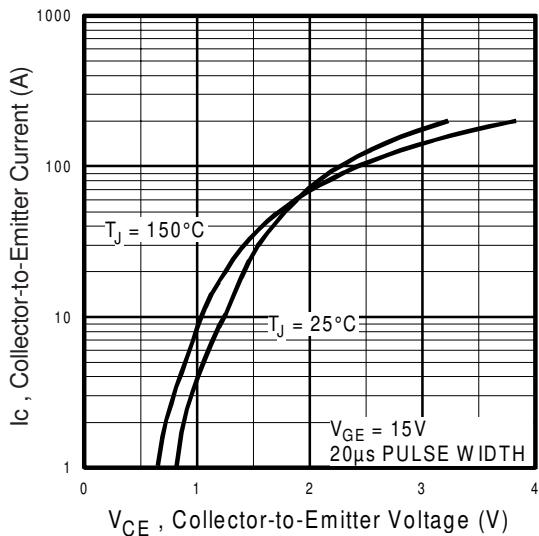


Fig. 2 - Typical Output Characteristics

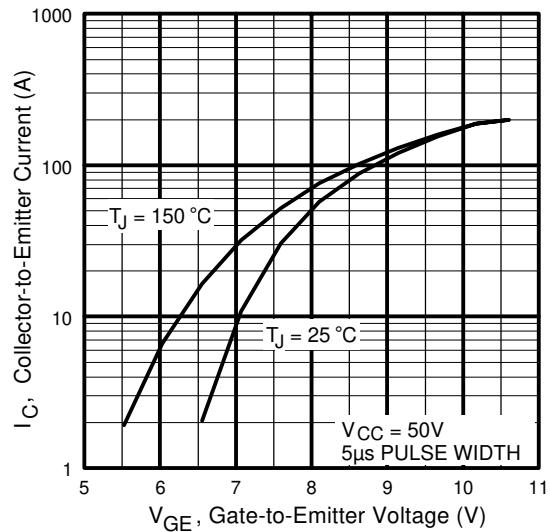


Fig. 3 - Typical Transfer Characteristics

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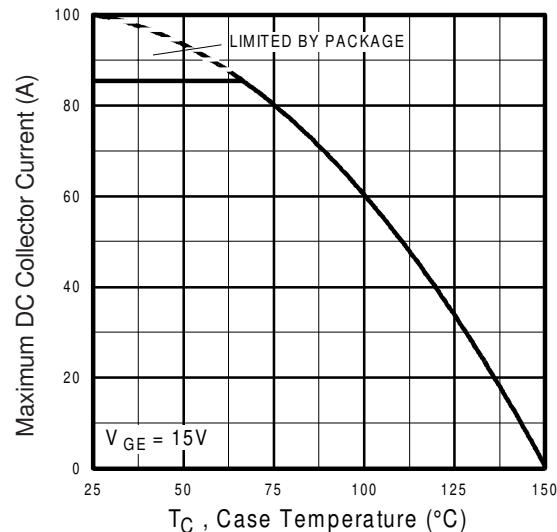


Fig. 4 - Maximum Collector Current vs. Case Temperature

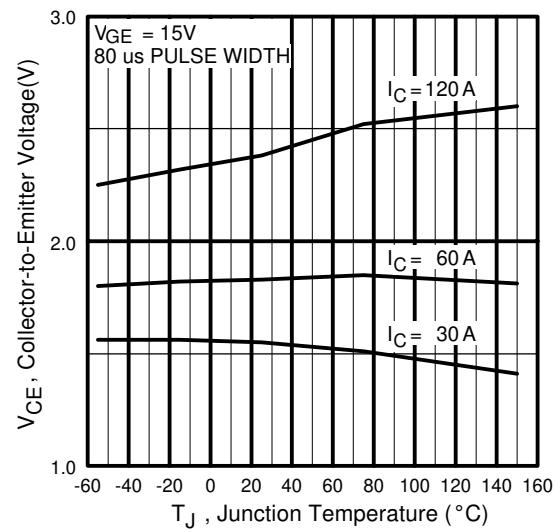


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

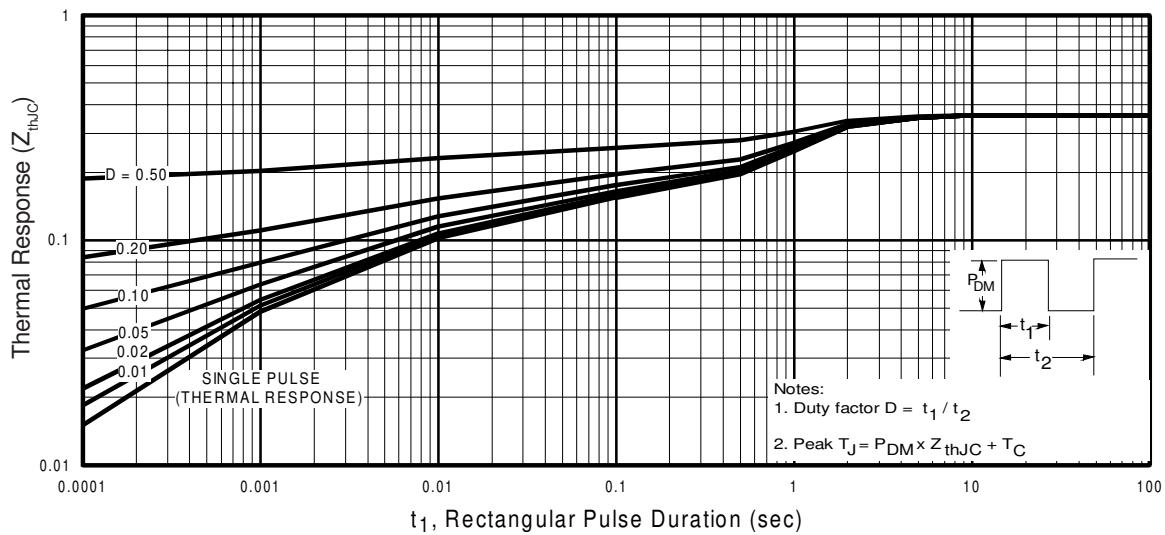


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

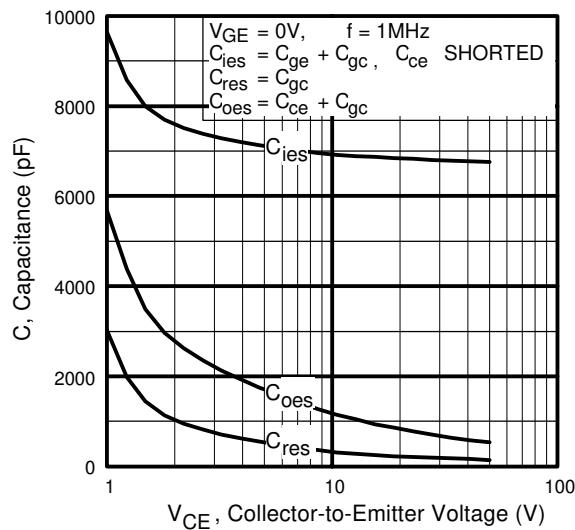


Fig. 7 - Typical Capacitance vs.
 Collector-to-Emitter Voltage

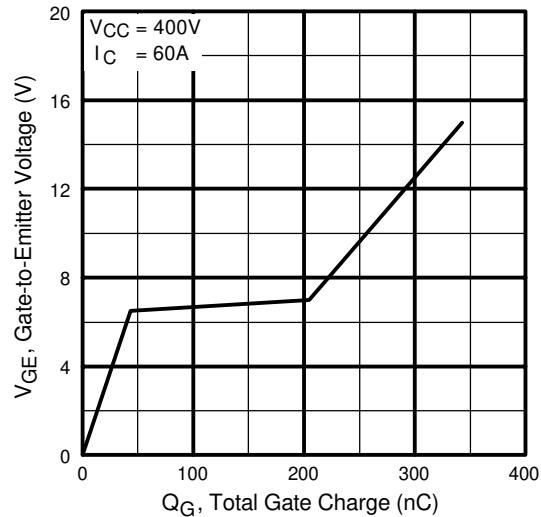


Fig. 8 - Typical Gate Charge vs.
 Gate-to-Emitter Voltage

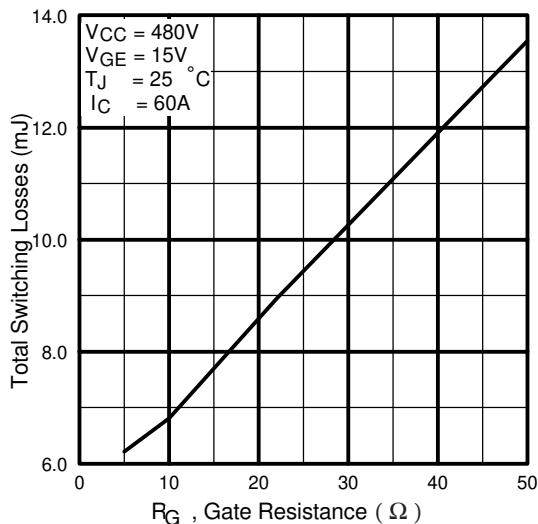


Fig. 9 - Typical Switching Losses vs. Gate
 Resistance

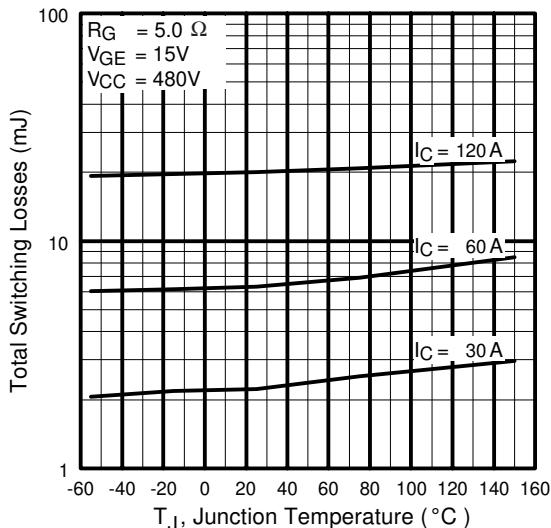


Fig. 10 - Typical Switching Losses vs.
 Junction Temperature

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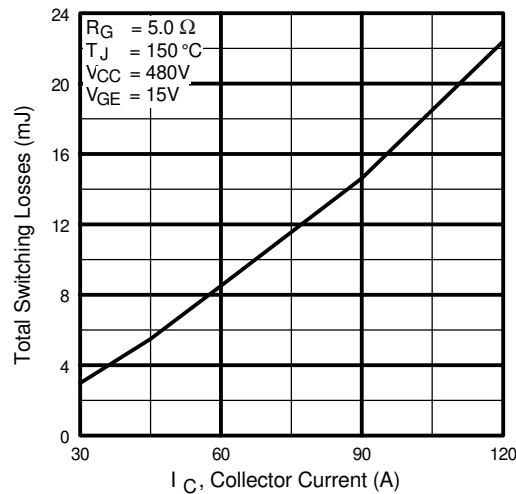


Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current

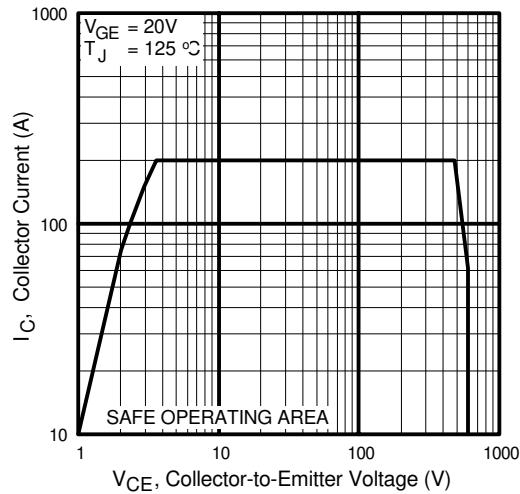


Fig. 12 - Turn-Off SOA

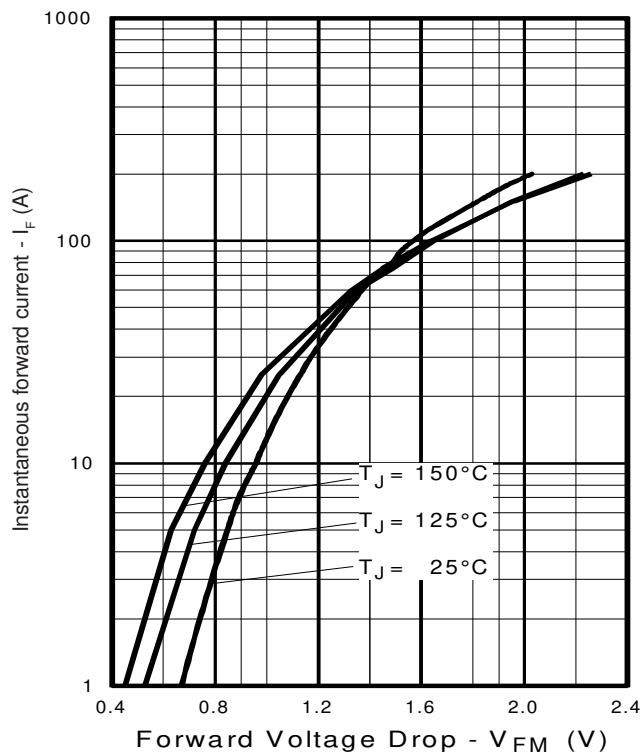


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

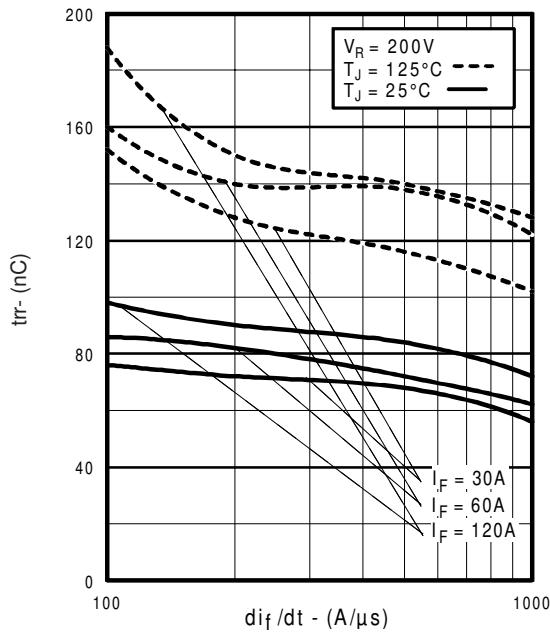


Fig. 14 - Typical Reverse Recovery vs. $\frac{di_f}{dt}$

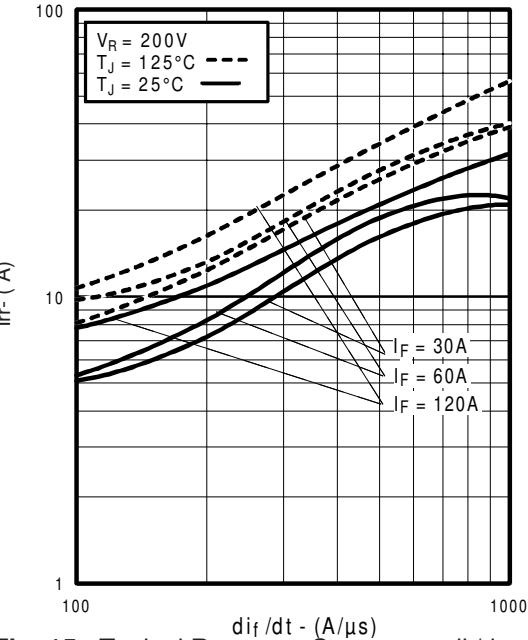


Fig. 15 - Typical Recovery Current vs. $\frac{di_f}{dt}$

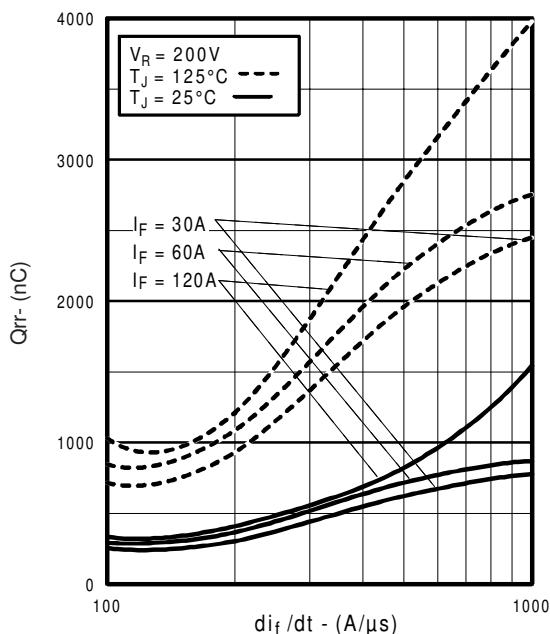


Fig. 16 - Typical Stored Charge vs. $\frac{di_f}{dt}$
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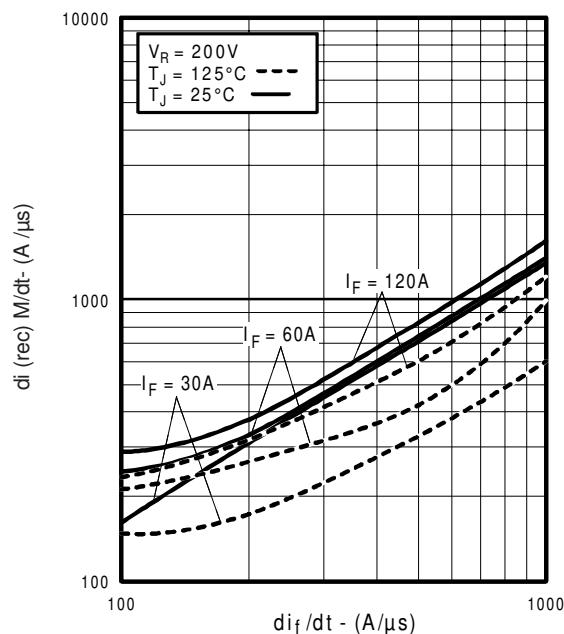


Fig. 17 - Typical $\frac{d(di_{(rec)}M)}{dt}$ vs. $\frac{di_f}{dt}$

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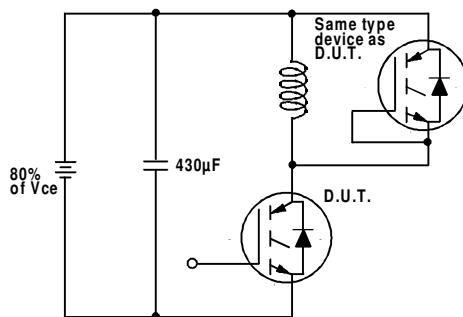


Fig. 18a - Test Circuit for Measurement of I_{LM} , E_{on} , $E_{off(diode)}$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

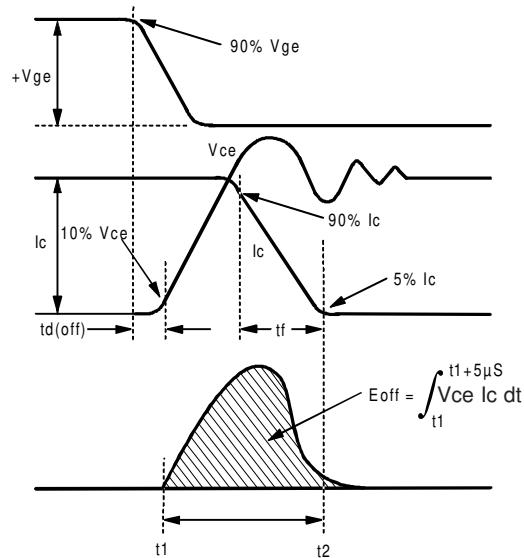


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining E_{off} , $t_{d(off)}$, t_f

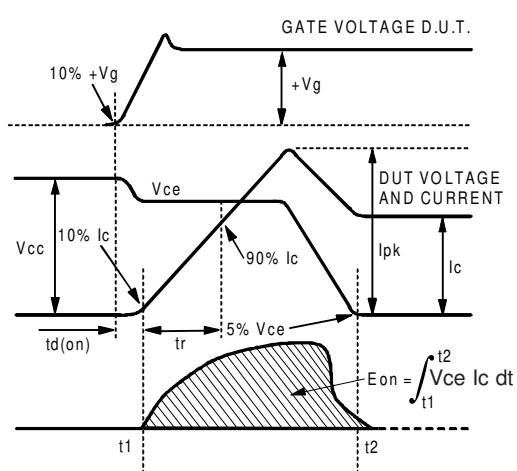


Fig. 18c - Test Waveforms for Circuit of Fig. 18a, Defining E_{on} , $t_{d(on)}$, t_r

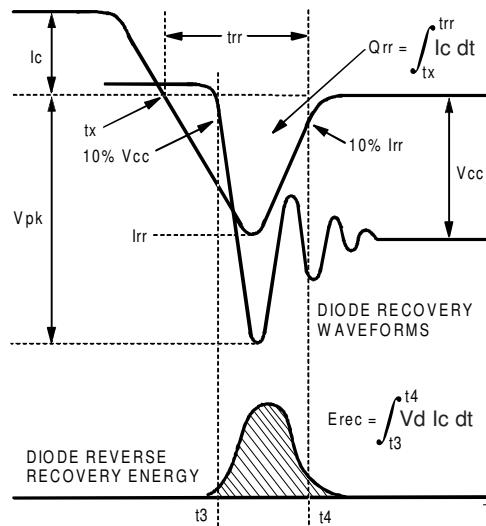


Fig. 18d - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

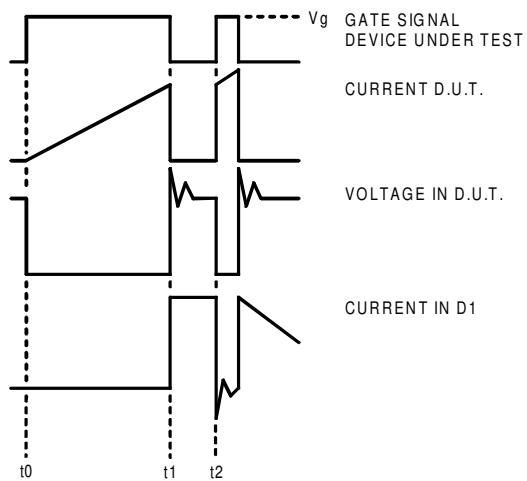


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

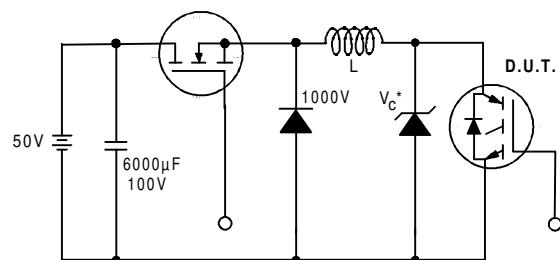


Figure 19. Clamped Inductive Load Test Circuit

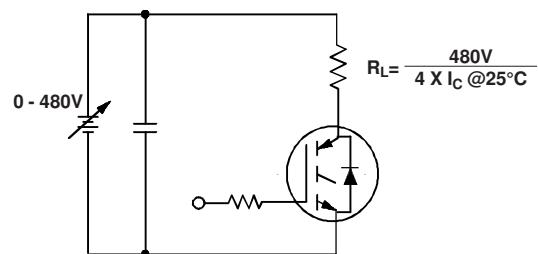


Figure 20. Pulsed Collector Current Test Circuit

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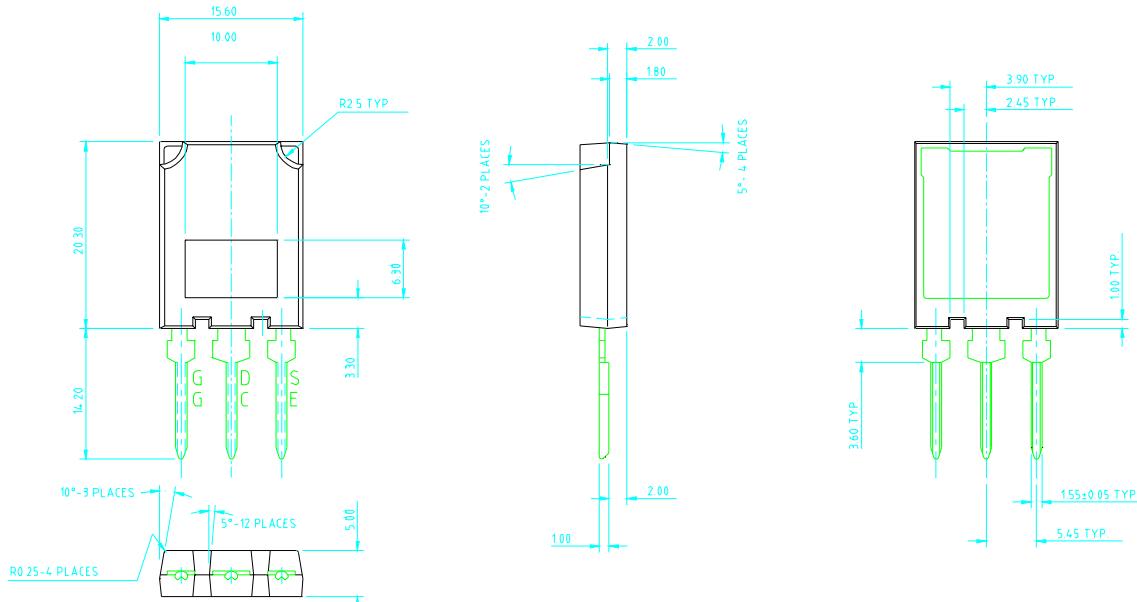
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Notes:

- ① Repetitive rating: $V_{GE}=20V$; pulse width limited by maximum junction temperature (figure 20)
- ② $V_{CC}=80\% (V_{CES})$, $V_{GE}=20V$, $L=10\mu H$, $R_G= 5.0\Omega$ (figure 19)
- ③ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$
- ④ Pulse width $5.0\mu s$, single shot
- ⑤ Current limited by the package, (Die current = 100A)

Case Outline and Dimensions — Super-247

Dimensions are shown in millimeters



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